4.5x2mm SMD CHIP LED LAMP

Part Number: APD2520YC03 Yellow

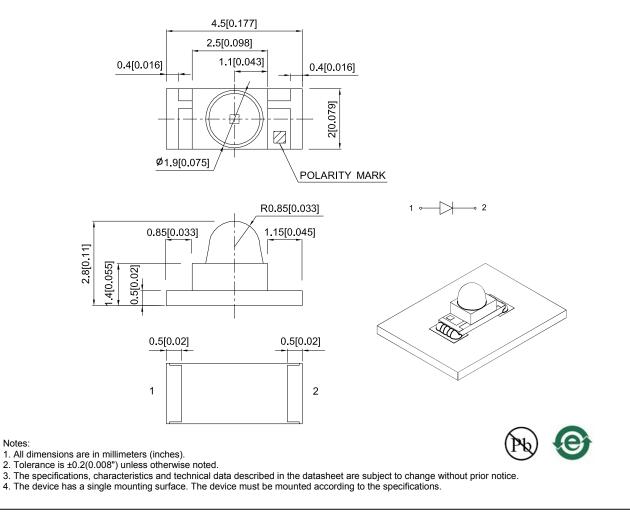
Features

- 4.5x2mm SMT LED,2.8mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 1000pcs/reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



SPEC NO: DSAA6584 APPROVED: WYNEC REV NO: V.10B CHECKED: Allen Liu DATE: APR/03/2015 DRAWN: L.Q.Xie PAGE: 1 OF 5 ERP: 1203001053

Selection Guide

Selection Guide					
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APD2520YC03	Yellow (GaAsP/GaP)	Water Clear	20	50	10°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity / luminous Flux: +/-15%.
Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Yellow	588		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	I⊧=20mA
С	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Yellow	2.1	2.5	V	I⊧=20mA
IR	Reverse Current	Yellow		10	uA	VR=5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

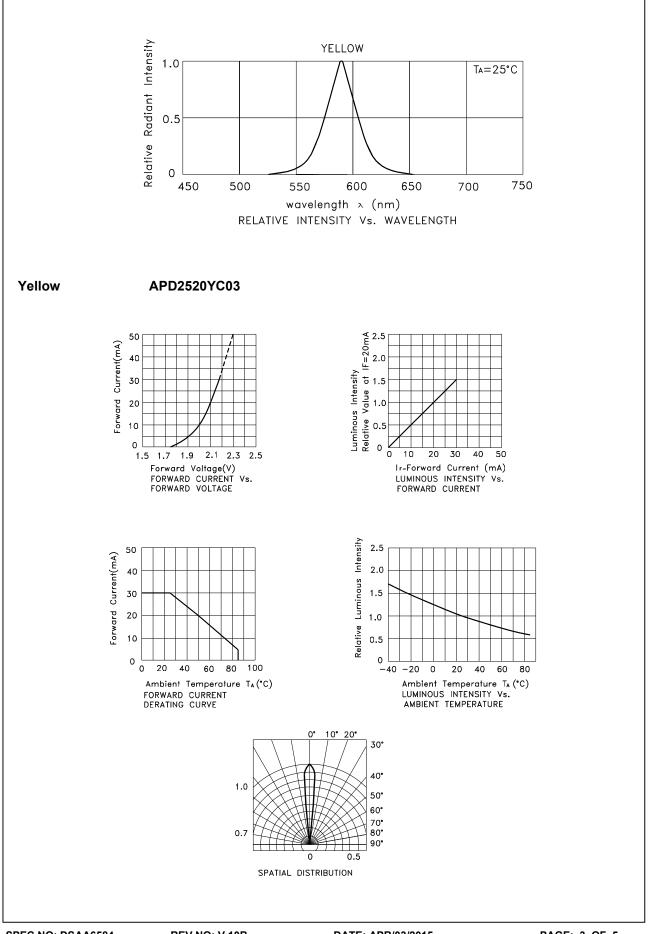
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Yellow	Units			
Power dissipation	75	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	140	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

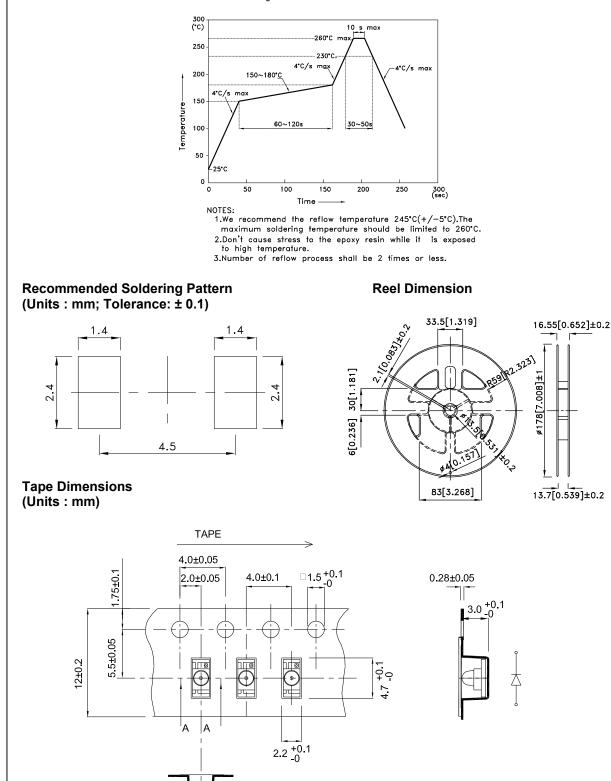
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



APD2520YC03

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

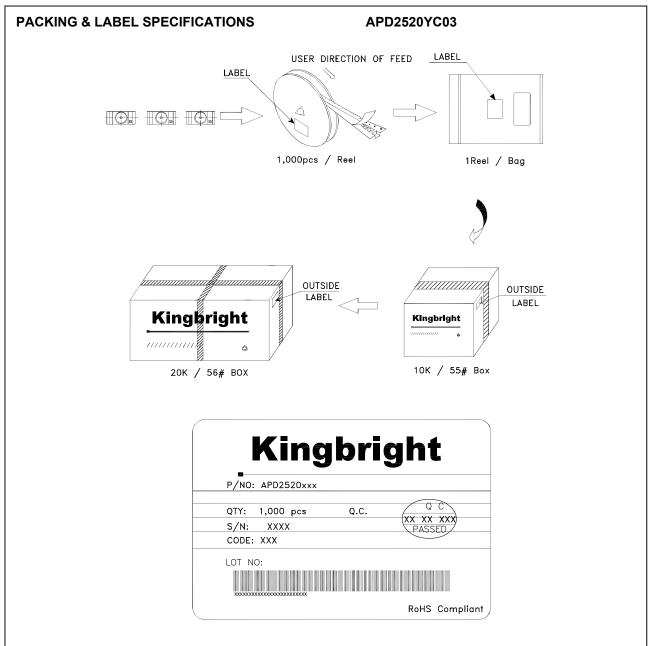
Reflow Soldering Profile For Lead-free SMT Process.



REV NO: V.10B CHECKED: Allen Liu

A-A SECTION

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